

# Designer's™ Data Sheet

## SWITCHMODE™

### NPN Bipolar Power Transistor

#### For Switching Power Supply Applications

The BUL146/BUL146F have an applications specific state-of-the-art die designed for use in fluorescent electric lamp ballasts to 130 Watts and in Switchmode Power supplies for all types of electronic equipment. These high voltage/high speed transistors offer the following:

- Improved Efficiency Due to Low Base Drive Requirements:
  - High and Flat DC Current Gain
  - Fast Switching
  - No Coil Required in Base Circuit for Turn-Off (No Current Tail)
- Full Characterization at 125°C
- Parametric Distributions are Tight and Consistent Lot-to-Lot
- Two Package Choices: Standard TO-220 or Isolated TO-220
- BUL146F, Isolated Case 221D, is UL Recognized to 3500 VRMS: File #E69369

#### MAXIMUM RATINGS

Rating	Symbol	BUL146	BUL146F	Unit
Collector-Emitter Sustaining Voltage	$V_{CEO}$	400		Vdc
Collector-Emitter Breakdown Voltage	$V_{CES}$	700		Vdc
Emitter-Base Voltage	$V_{EBO}$	9.0		Vdc
Collector Current — Continuous	$I_C$	6.0		Adc
— Peak(1)	$I_{CM}$	15		
Base Current — Continuous	$I_B$	4.0		Adc
— Peak(1)	$I_{BM}$	8.0		
RMS Isolated Voltage(2) (for 1 sec, R.H. < 30%, $T_C = 25^\circ\text{C}$ )	$V_{ISOL}$	—	4500 3500 1500	V
Total Device Dissipation ( $T_C = 25^\circ\text{C}$ ) Derate above 25°C	$P_D$	100 0.8	40 0.32	Watts W/°C
Operating and Storage Temperature	$T_J, T_{stg}$	- 65 to 150		°C

#### THERMAL CHARACTERISTICS

Rating	Symbol	BUL146	BUL146F	Unit
Thermal Resistance — Junction to Case	$R_{\theta JC}$	1.25	3.125	°C/W
— Junction to Ambient	$R_{\theta JA}$	62.5	62.5	
Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	$T_L$	260		°C

#### ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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#### OFF CHARACTERISTICS

Collector-Emitter Sustaining Voltage ( $I_C = 100\text{ mA}, L = 25\text{ mH}$ )	$V_{CEO(sus)}$	400	—	—	Vdc
Collector Cutoff Current ( $V_{CE} = \text{Rated } V_{CEO}, I_B = 0$ )	$I_{CEO}$	—	—	100	$\mu\text{Adc}$
Collector Cutoff Current ( $V_{CE} = \text{Rated } V_{CES}, V_{EB} = 0$ )	$I_{CES}$	—	—	100	$\mu\text{Adc}$
( $T_C = 125^\circ\text{C}$ )		—	—	500	
( $V_{CE} = 500\text{ V}, V_{EB} = 0$ )		—	—	100	
( $T_C = 125^\circ\text{C}$ )		—	—	100	
Emitter Cutoff Current ( $V_{EB} = 9.0\text{ Vdc}, I_C = 0$ )	$I_{EBO}$	—	—	100	$\mu\text{Adc}$

(1) Pulse Test: Pulse Width = 5.0 ms, Duty Cycle  $\leq 10\%$ .

(2) Proper strike and creepage distance must be provided.

(continued)

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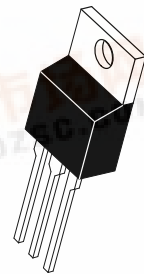
**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

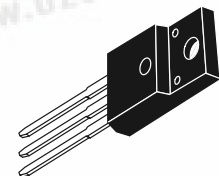
**BUL146\***  
**BUL146F\***

\*Motorola Preferred Device

**POWER TRANSISTOR**  
**6.0 AMPERES**  
**700 VOLTS**  
**40 and 100 WATTS**



**BUL146**  
**CASE 221A-06**  
**TO-220AB**



**BUL146F**  
**CASE 221D-02**  
**ISOLATED TO-220 TYPE**  
**UL RECOGNIZED**

# BUL146 BUL146F

## ELECTRICAL CHARACTERISTICS — continued (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>ON CHARACTERISTICS</b>					
Base–Emitter Saturation Voltage (I <sub>C</sub> = 1.3 Adc, I <sub>B</sub> = 0.13 Adc) (I <sub>C</sub> = 3.0 Adc, I <sub>B</sub> = 0.6 Adc)	V <sub>BE(sat)</sub>	—	0.82 0.93	1.1 1.25	Vdc
Collector–Emitter Saturation Voltage (I <sub>C</sub> = 1.3 Adc, I <sub>B</sub> = 0.13 Adc) (T <sub>C</sub> = 125°C) (I <sub>C</sub> = 3.0 Adc, I <sub>B</sub> = 0.6 Adc) (T <sub>C</sub> = 125°C)	V <sub>CE(sat)</sub>	—	0.22 0.20 0.30 0.30	0.5 0.5 0.7 0.7	Vdc
DC Current Gain (I <sub>C</sub> = 0.5 Adc, V <sub>CE</sub> = 5.0 Vdc) (T <sub>C</sub> = 125°C) (I <sub>C</sub> = 1.3 Adc, V <sub>CE</sub> = 1.0 Vdc) (T <sub>C</sub> = 125°C) (I <sub>C</sub> = 3.0 Adc, V <sub>CE</sub> = 1.0 Vdc) (T <sub>C</sub> = 125°C) (I <sub>C</sub> = 10 mAdc, V <sub>CE</sub> = 5.0 Vdc) (T <sub>C</sub> = 125°C)	h <sub>FE</sub>	14 — 12 12 8.0 7.0 10	— 30 20 20 13 12 20	34 — — — — — —	—

## DYNAMIC CHARACTERISTICS

Current Gain Bandwidth (I <sub>C</sub> = 0.5 Adc, V <sub>CE</sub> = 10 Vdc, f = 1.0 MHz)	f <sub>T</sub>	—	14	—	MHz	
Output Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)	C <sub>OB</sub>	—	95	150	pF	
Input Capacitance (V <sub>EB</sub> = 8.0 V)	C <sub>IB</sub>	—	1000	1500	pF	
Dynamic Saturation Voltage: Determined 1.0 μs and 3.0 μs respectively after rising I <sub>B1</sub> reaches 90% of final I <sub>B1</sub> (see Figure 18)	(I <sub>C</sub> = 1.3 Adc I <sub>B1</sub> = 300 mAdc V <sub>CC</sub> = 300 V)	1.0 μs (T <sub>C</sub> = 125°C)	—	2.5	—	V
		3.0 μs (T <sub>C</sub> = 125°C)	—	6.5	—	
	(I <sub>C</sub> = 3.0 Adc I <sub>B1</sub> = 0.6 Adc V <sub>CC</sub> = 300 V)	1.0 μs (T <sub>C</sub> = 125°C)	—	0.6	—	
		3.0 μs (T <sub>C</sub> = 125°C)	—	2.5	—	
			V <sub>CE(dsat)</sub>	—	3.0	—
				—	7.0	—
				—	0.75	—
				—	1.4	—

## SWITCHING CHARACTERISTICS: Resistive Load (D.C. ≤ 10%, Pulse Width = 20 μs)

Turn–On Time	(I <sub>C</sub> = 1.3 Adc, I <sub>B1</sub> = 0.13 Adc I <sub>B2</sub> = 0.65 Adc, V <sub>CC</sub> = 300 V) (T <sub>C</sub> = 125°C)	t <sub>on</sub>	—	100	200	ns
Turn–Off Time		t <sub>off</sub>	—	1.35	2.5	μs
	(T <sub>C</sub> = 125°C)		—	1.90	—	
Turn–On Time	(I <sub>C</sub> = 3.0 Adc, I <sub>B1</sub> = 0.6 Adc I <sub>B1</sub> = 1.5 Adc, V <sub>CC</sub> = 300 V) (T <sub>C</sub> = 125°C)	t <sub>on</sub>	—	90	150	ns
Turn–Off Time		t <sub>off</sub>	—	1.7	2.5	μs
	(T <sub>C</sub> = 125°C)		—	2.1	—	

## SWITCHING CHARACTERISTICS: Inductive Load (V<sub>clamp</sub> = 300 V, V<sub>CC</sub> = 15 V, L = 200 μH)

Fall Time	(I <sub>C</sub> = 1.3 Adc, I <sub>B1</sub> = 0.13 Adc I <sub>B2</sub> = 0.65 Adc) (T <sub>C</sub> = 125°C)	t <sub>fi</sub>	—	115	200	ns
Storage Time		t <sub>si</sub>	—	1.35	2.5	μs
Crossover Time		t <sub>c</sub>	—	1.75	—	
	(T <sub>C</sub> = 125°C)		—	200	350	ns
	(T <sub>C</sub> = 125°C)		—	210	—	
Fall Time	(I <sub>C</sub> = 3.0 Adc, I <sub>B1</sub> = 0.6 Adc I <sub>B2</sub> = 1.5 Adc) (T <sub>C</sub> = 125°C)	t <sub>fi</sub>	—	85	150	ns
Storage Time		t <sub>si</sub>	—	1.75	2.5	μs
Crossover Time		t <sub>c</sub>	—	2.25	—	
	(T <sub>C</sub> = 125°C)		—	175	300	ns
	(T <sub>C</sub> = 125°C)		—	200	—	
Fall Time	(I <sub>C</sub> = 3.0 Adc, I <sub>B1</sub> = 0.6 Adc I <sub>B2</sub> = 0.6 Adc) (T <sub>C</sub> = 125°C)	t <sub>fi</sub>	80	—	180	ns
Storage Time		t <sub>si</sub>	2.6	—	3.8	μs
Crossover Time		t <sub>c</sub>	—	4.5	—	
	(T <sub>C</sub> = 125°C)		—	230	350	ns
	(T <sub>C</sub> = 125°C)		—	400	—	

TYPICAL STATIC CHARACTERISTICS

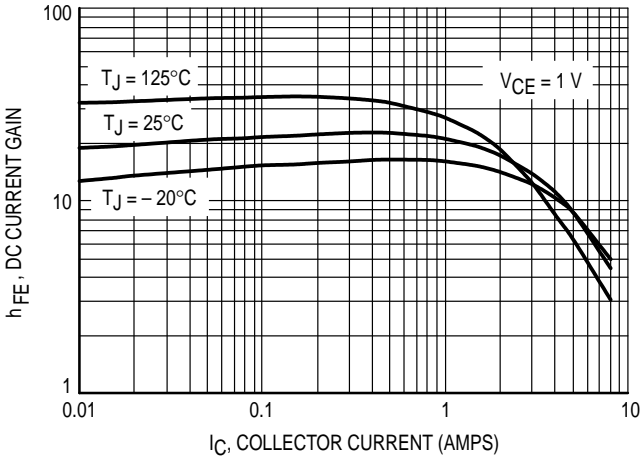


Figure 1. DC Current Gain @ 1 Volt

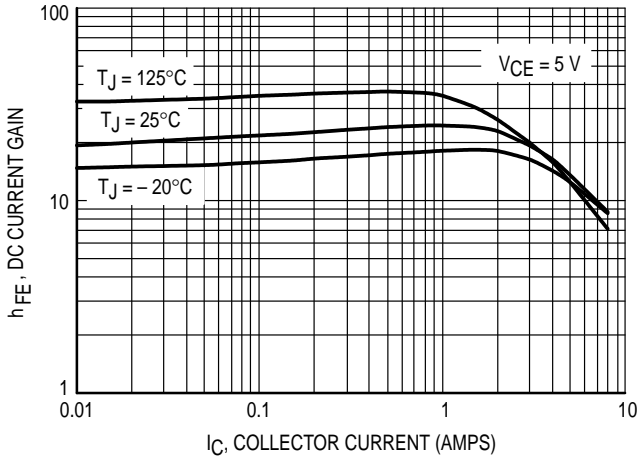


Figure 2. DC Current Gain @ 5 Volts

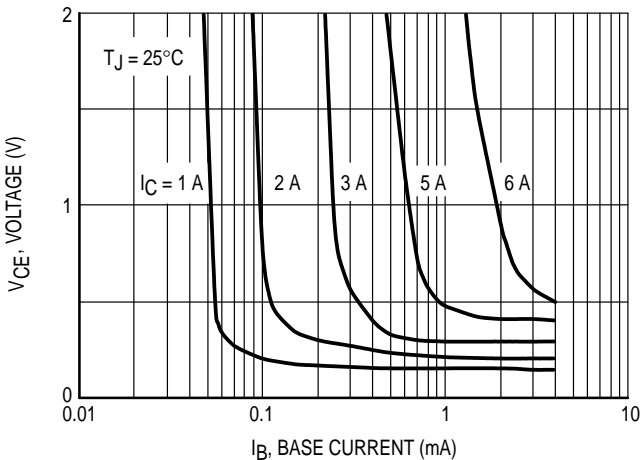


Figure 3. Collector Saturation Region

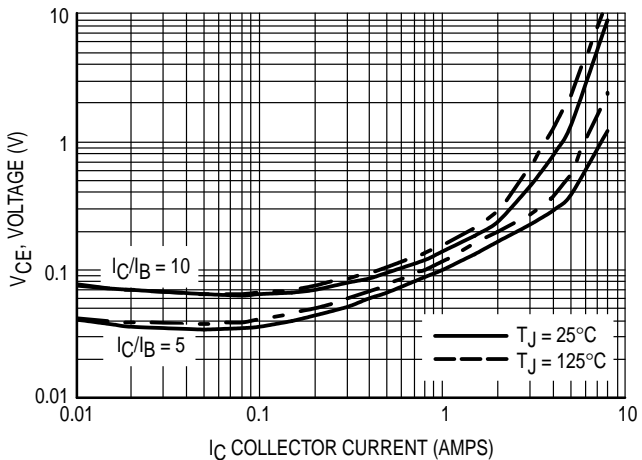


Figure 4. Collector-Emitter Saturation Voltage

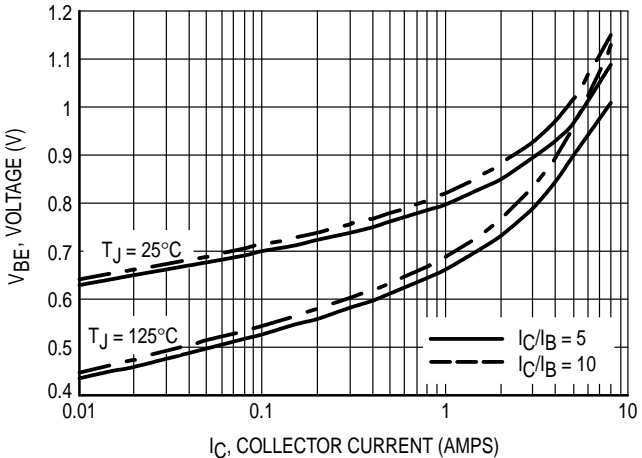


Figure 5. Base-Emitter Saturation Region

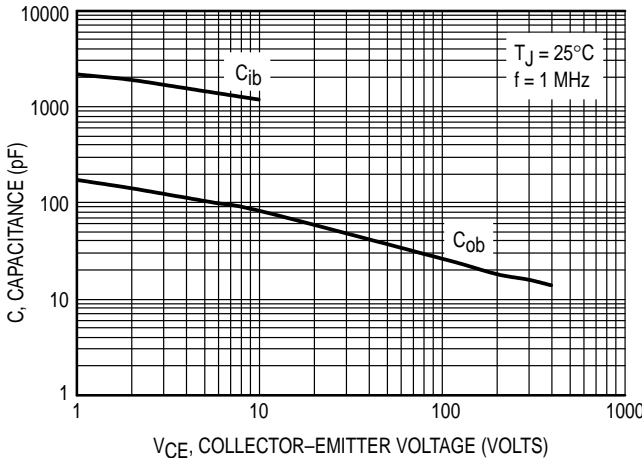
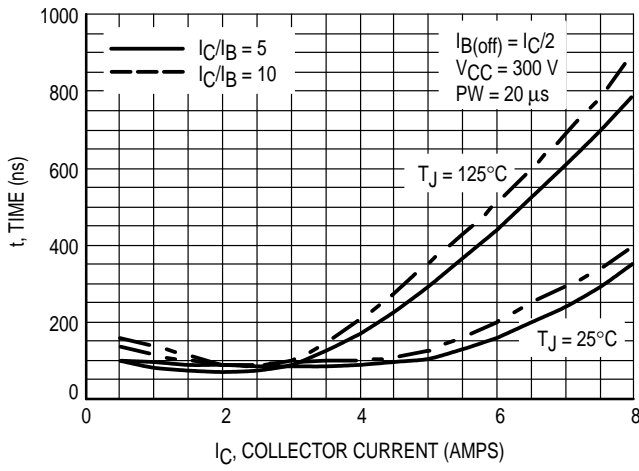
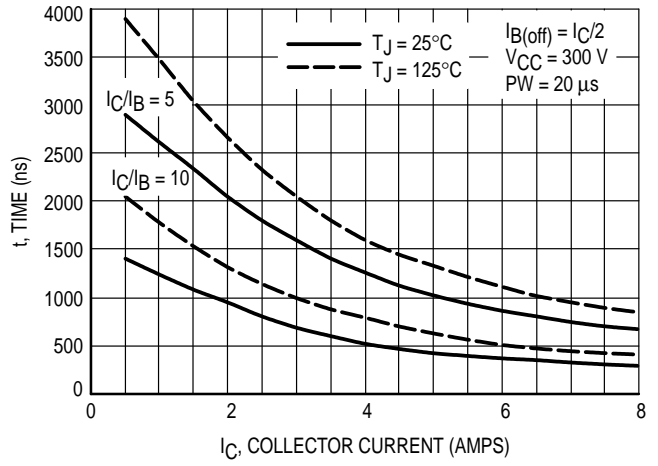


Figure 6. Capacitance

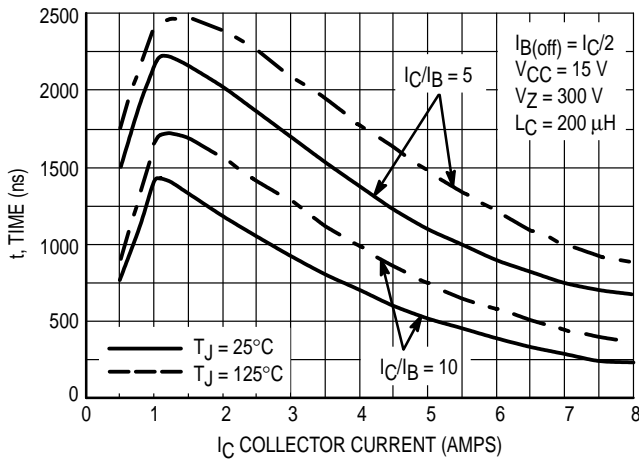
**TYPICAL SWITCHING CHARACTERISTICS**  
( $I_{B2} = I_C/2$  for all switching)



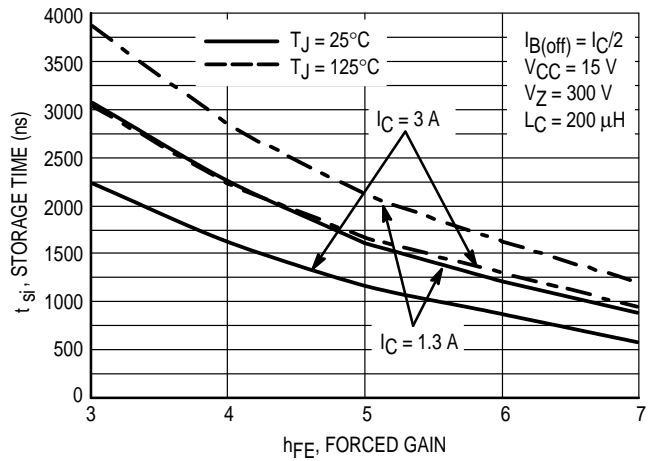
**Figure 7. Resistive Switching,  $t_{on}$**



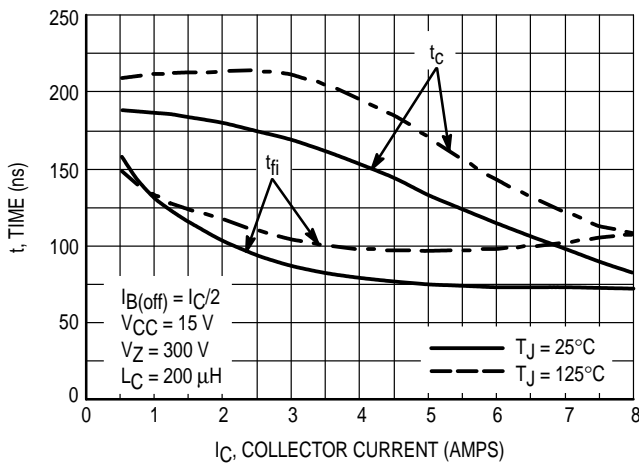
**Figure 8. Resistive Switching,  $t_{off}$**



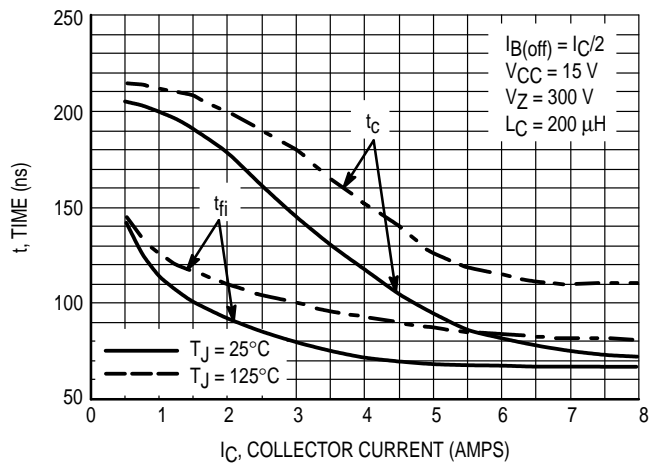
**Figure 9. Inductive Storage Time,  $t_{si}$**



**Figure 10. Inductive Storage Time,  $t_{si}(h_{FE})$**



**Figure 11. Inductive Switching,  $t_c$  and  $t_{fi}$**   
 $I_C/I_B = 5$



**Figure 12. Inductive Switching,  $t_c$  and  $t_{fi}$**   
 $I_C/I_B = 10$

**TYPICAL SWITCHING CHARACTERISTICS**  
( $I_{B2} = I_C/2$  for all switching)

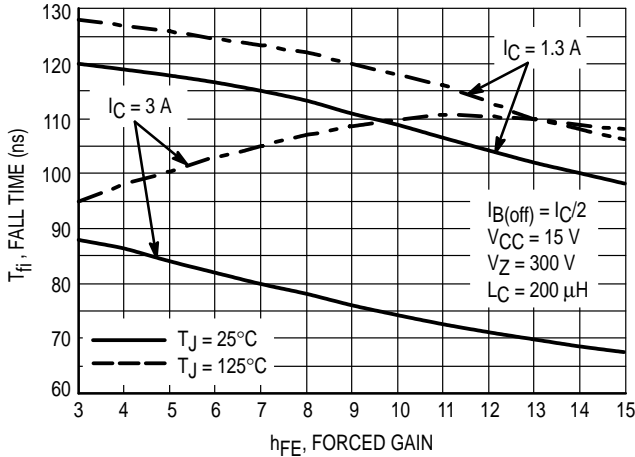


Figure 13. Inductive Fall Time

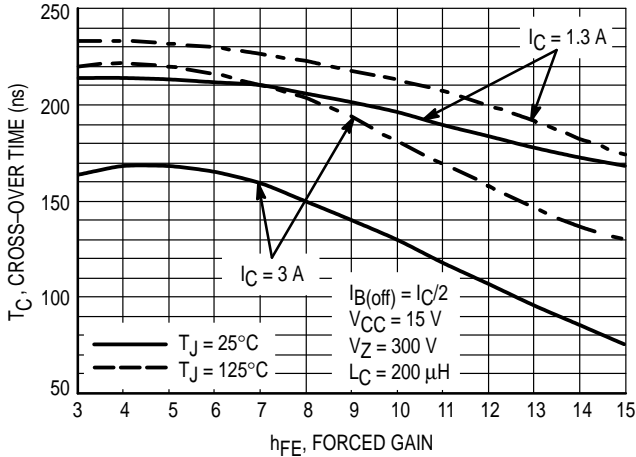


Figure 14. Inductive Cross-Over Time

**GUARANTEED SAFE OPERATING AREA INFORMATION**

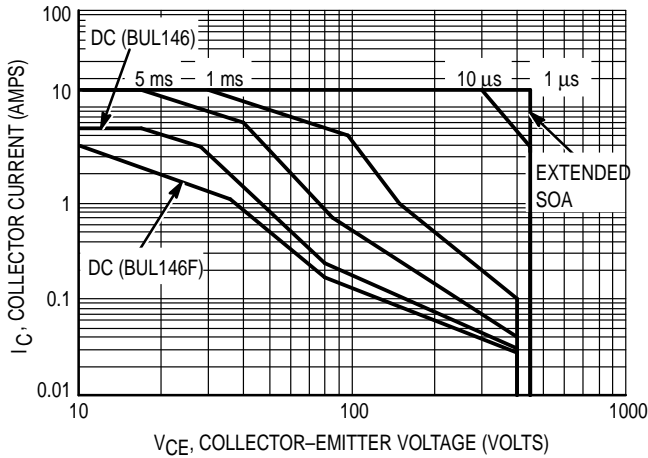


Figure 15. Forward Bias Safe Operating Area

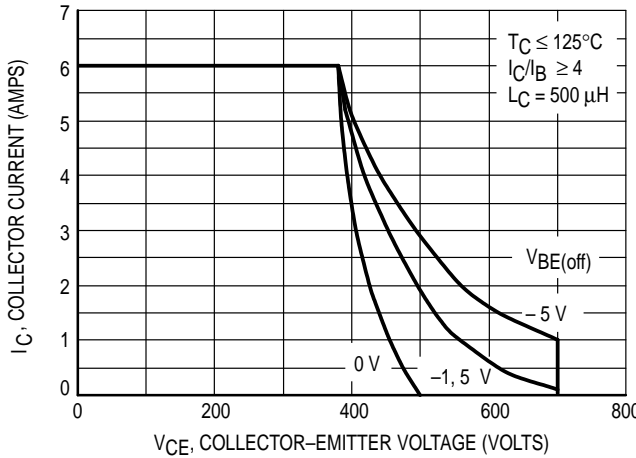


Figure 16. Reverse Bias Switching Safe Operating Area

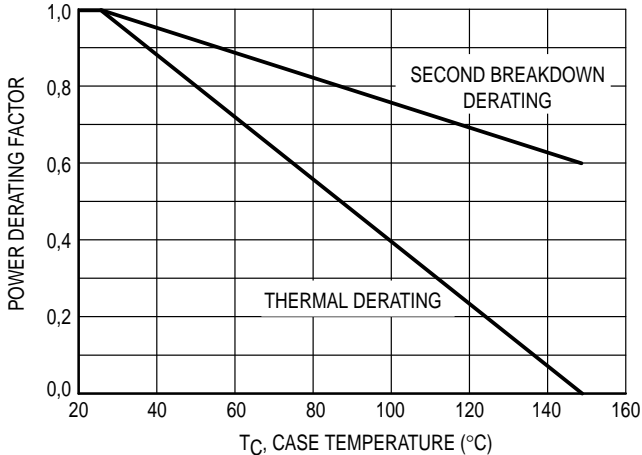
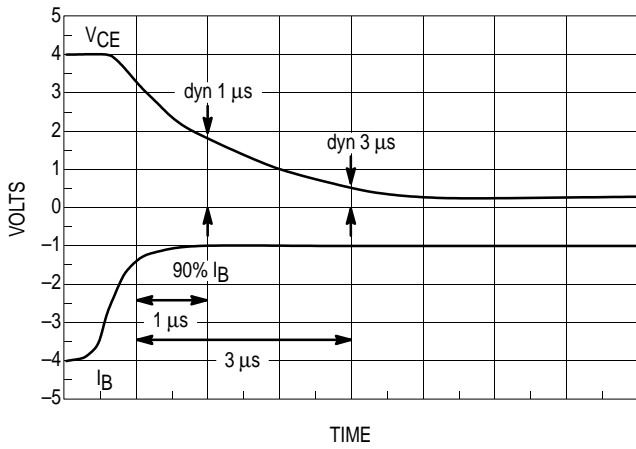


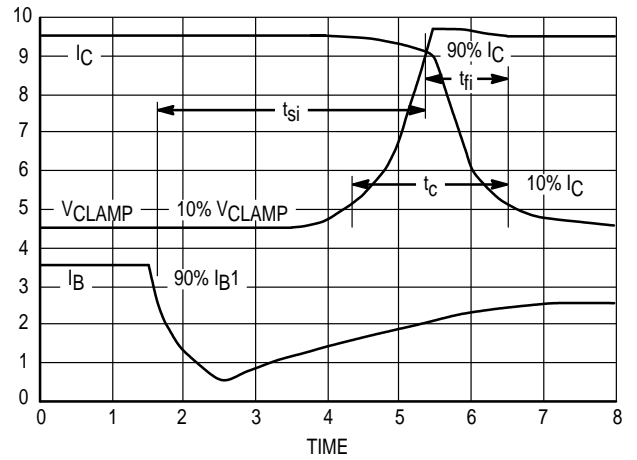
Figure 17. Forward Bias Power Derating

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate. The data of Figure 15 is based on  $T_C = 25^\circ\text{C}$ ;  $T_{J(pk)}$  is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when  $T_C > 25^\circ\text{C}$ . Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown in Figure 15 may be found at any case temperature by using the appropriate curve on Figure 17.  $T_{J(pk)}$  may be calculated from the data in Figure 20 and 21. At any case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. For inductive loads, high voltage and current must be sustained simultaneously during turn-off with the base-to-emitter junction reverse-biased. The safe level is specified as a reverse-biased safe operating area (Figure 16). This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode.

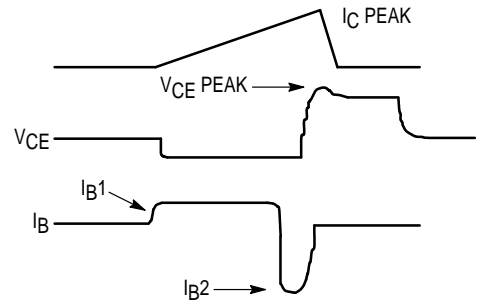
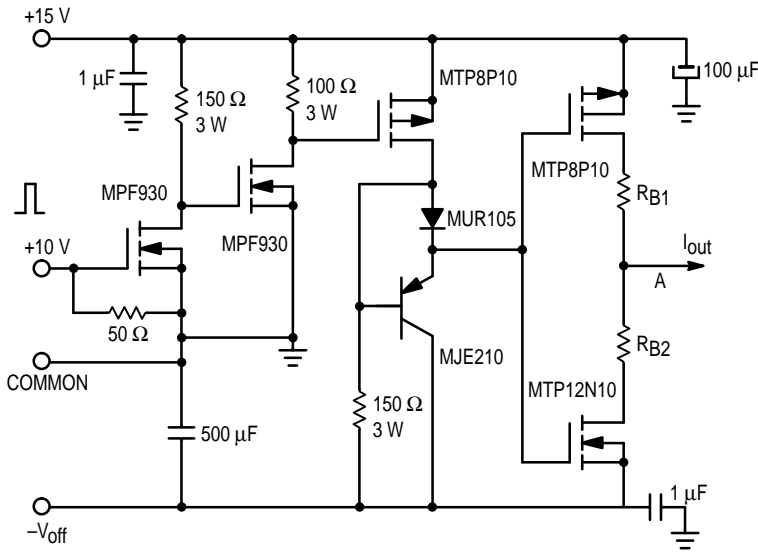
**BUL146 BUL146F**



**Figure 18. Dynamic Saturation Voltage Measurements**



**Figure 19. Inductive Switching Measurements**



V(BR)CEO(sus)	INDUCTIVE SWITCHING	RBSOA
L = 10 mH	L = 200 μH	L = 500 μH
RB2 = ∞	RB2 = 0	RB2 = 0
VCC = 20 VOLTS	VCC = 15 VOLTS	VCC = 15 VOLTS
IC(pk) = 100 mA	RB1 SELECTED FOR DESIRED IB1	RB1 SELECTED FOR DESIRED IB1

**Table 1. Inductive Load Switching Drive Circuit**

TYPICAL THERMAL RESPONSE

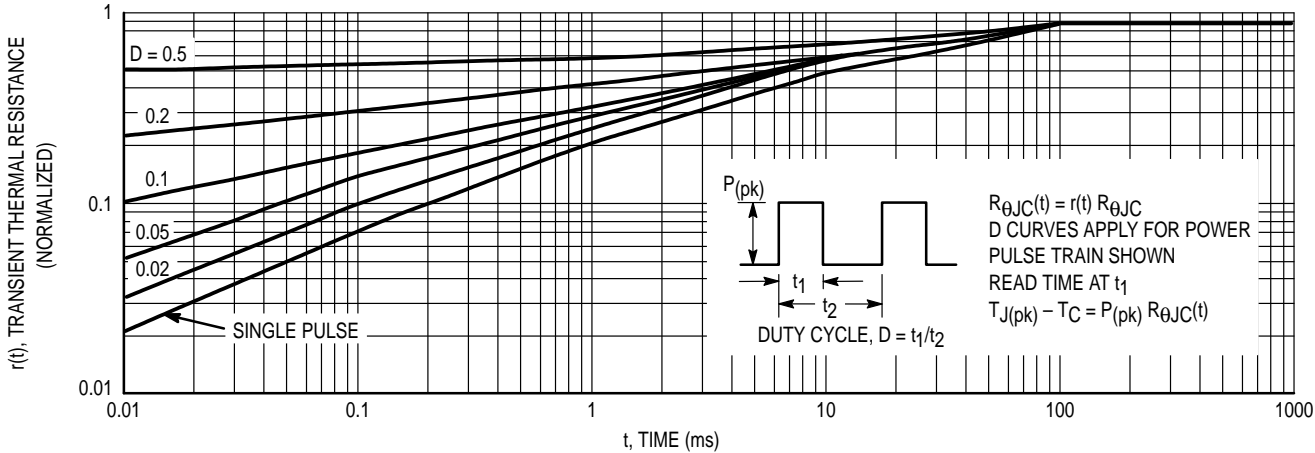


Figure 20. Typical Thermal Response ( $Z_{\theta JC}(t)$ ) for BUL146

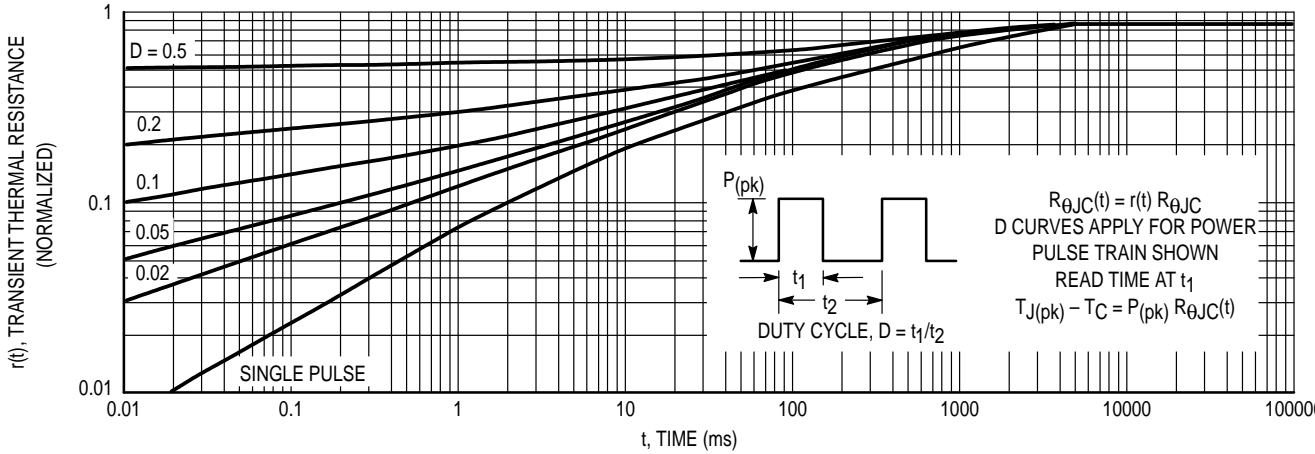
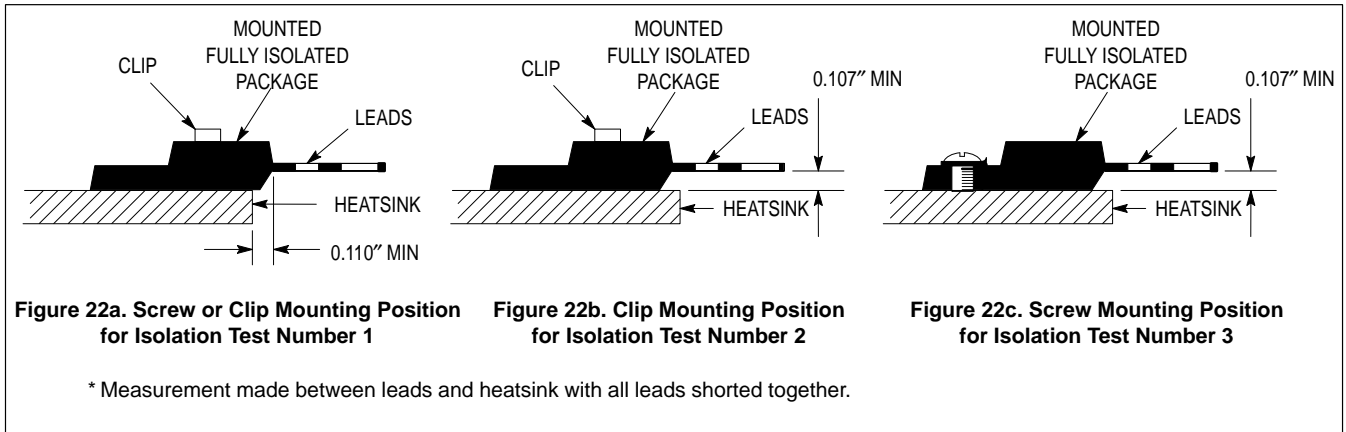
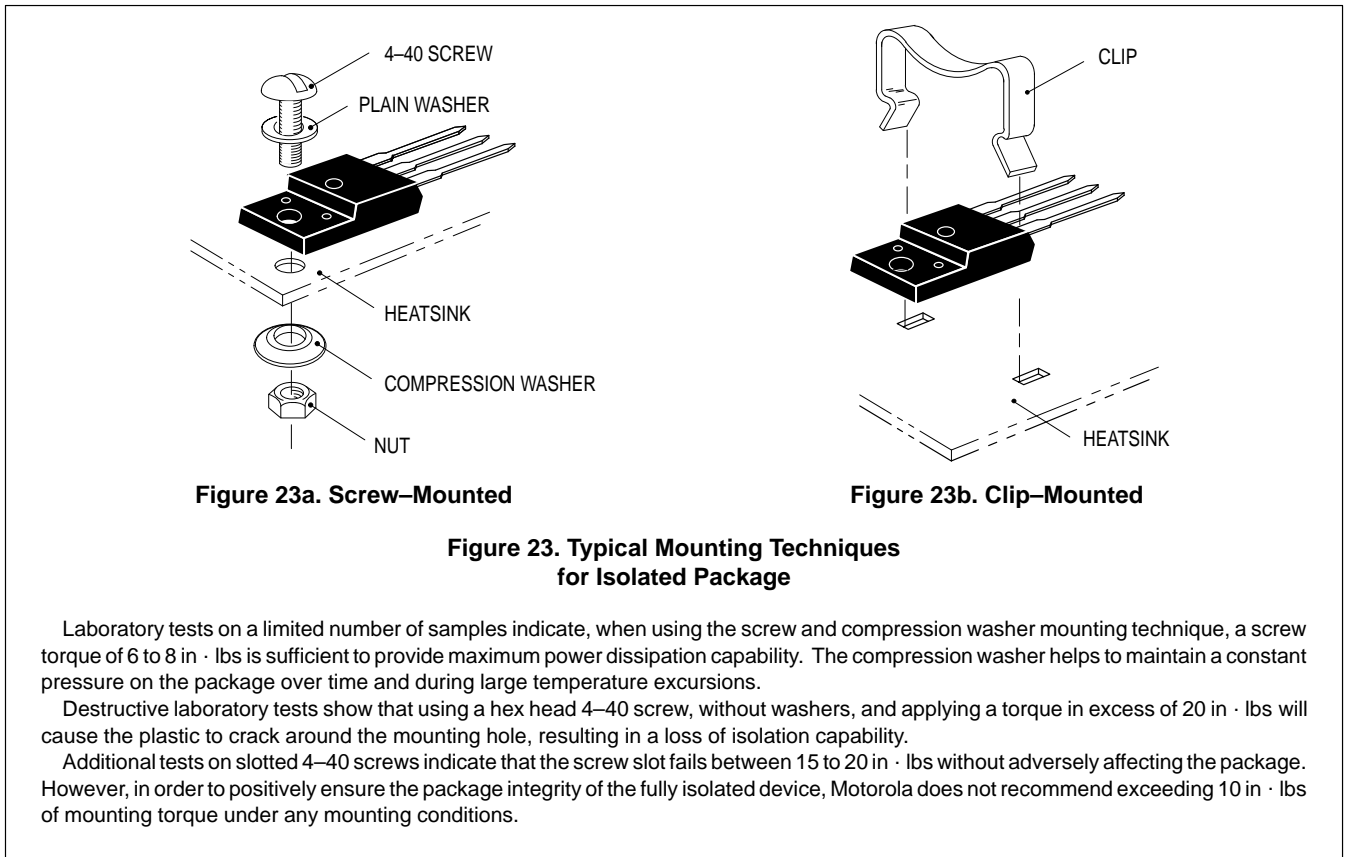


Figure 21. Typical Thermal Response ( $Z_{\theta JC}(t)$ ) for BUL146F

**TEST CONDITIONS FOR ISOLATION TESTS\***



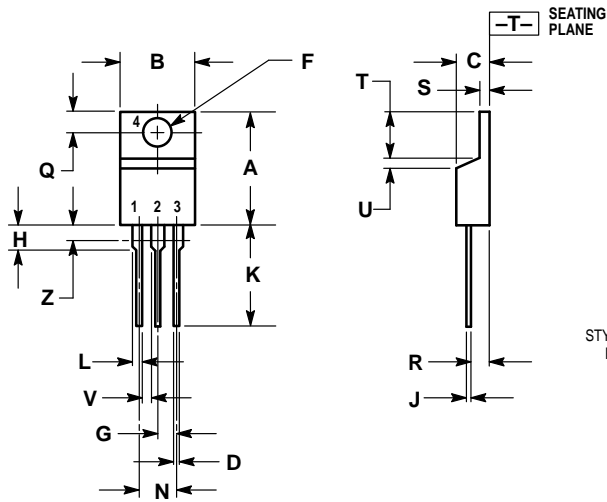
**MOUNTING INFORMATION\*\***



\*\* For more information about mounting power semiconductors see Application Note AN1040.



**PACKAGE DIMENSIONS**

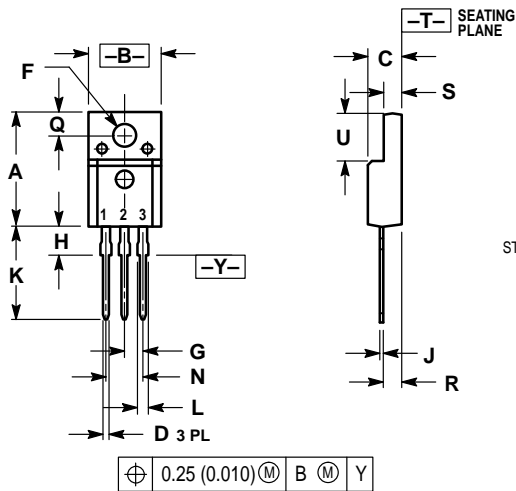


- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.  
 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	—	1.15	—
Z	—	0.080	—	2.04

- STYLE 1:  
 PIN 1. BASE  
 2. COLLECTOR  
 3. EMITTER  
 4. COLLECTOR

**BUL44  
 CASE 221A-06  
 TO-220AB  
 ISSUE Y**



- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.


DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.621	0.629	15.78	15.97
B	0.394	0.402	10.01	10.21
C	0.181	0.189	4.60	4.80
D	0.026	0.034	0.67	0.86
F	0.121	0.129	3.08	3.27
G	0.100 BSC	—	2.54 BSC	—
H	0.123	0.129	3.13	3.27
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.14	1.52
N	0.200 BSC	—	5.08 BSC	—
Q	0.126	0.134	3.21	3.40
R	0.107	0.111	2.72	2.81
S	0.096	0.104	2.44	2.64
U	0.259	0.267	6.58	6.78

- STYLE 2:  
 PIN 1. BASE  
 2. COLLECTOR  
 3. EMITTER

⊕ 0.25 (0.010) M B M Y

**BUL44F  
 CASE 221D-02  
 (ISOLATED TO-220 TYPE)  
 ISSUE D**

## BUL146 BUL146F

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